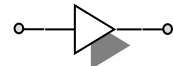


Features

- S_{21} = 20.5 dB @ 890 MHz
= 19.5 dB @ 960 MHz
- NF of 0.8 dB over Frequency
- Unconditionally Stable
- Single 5V Supply
- High OIP3 @ Low Current

Description

The plerow™ ALN-series is the compactly designed surface-mount module for the use of the LNA with or without the following gain blocks in the infrastructure equipment of the mobile wireless (CDMA, GSM, PCS, PHS, WCDMA, DMB, WLAN, WiBro, WiMAX), GPS, satellite communication terminals, CATV and so on. It has an exceptional performance of low noise figure, high gain, high OIP3, and low bias current. The stability factor is always kept more than unity over the application band in order to ensure its unconditionally stable implementation to the application system environment. The surface-mount module package including the completed matching circuit and other components necessary just in case allows very simple and convenient implementation onto the system board in mass production level.



1-stage Single Type

Specifications (in Production)

Typ. @ T = 25°C, V_s = 5 V, Freq. = 925 MHz, $Z_{o,sys}$ = 50 ohm

Parameter	Unit	Specifications		
		Min	Typ	Max
Frequency Range	MHz	890		960
Gain	dB	19	20	
Gain Flatness	dB		± 0.5	± 0.7
Noise Figure	dB		0.8	0.85
Output IP3 ⁽¹⁾	dBm	30	31	
S11 / S22 ⁽²⁾	dB			-14 / -14
Output P1dB	dBm	16	17	
Switching Time	µsec		-	
Supply Current	mA		70	80
Supply Voltage	V		5	
Impedance	Ω		50	
Max. RF Input Power	dBm	C.W 29 ~ 31 (before fail)		
Package Type & Size	mm	Surface Mount Type, 10Wx10Lx3.8H		

More Information

Website: www.asb.co.kr
E-mail: sales@asb.co.kr
Tel: (82) 42-528-7223
Fax: (82) 42-528-7222

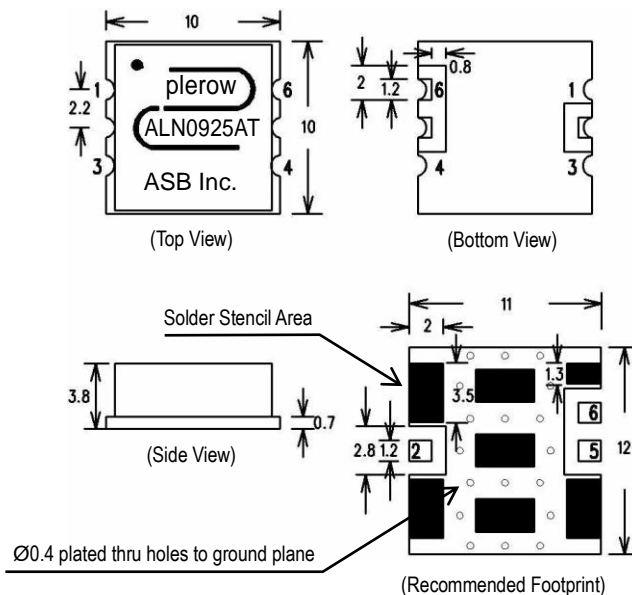
Operating temperature is -40°C to +85°C.

1) OIP3 is measured with two tones at an output power of 8 dBm / tone separated by 1 MHz.

2) S11/S22 (max) is the worst value within the frequency band.

3) Switching time means the time that takes for output power to get stabilized to its final level after switching DC voltage from 0 V to V_s .

Outline Drawing (Unit: mm)



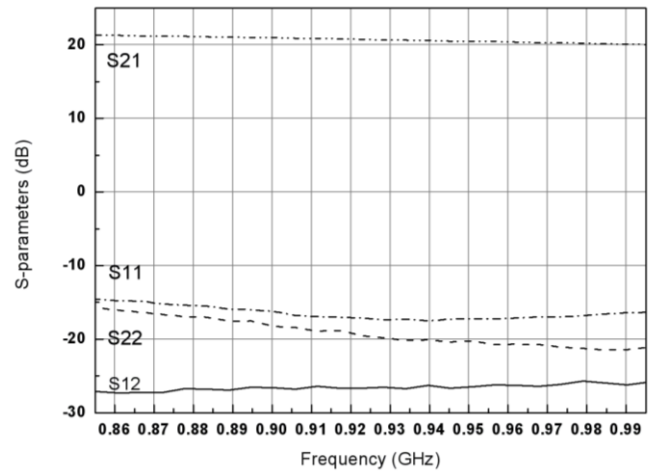
Pin Number	Function
2	RF In
5	RF Out
6	+Vcc
Others	Ground

- Note: 1. The number and size of ground via holes in a circuit board is critical for thermal RF grounding considerations.
2. We recommend that the ground via holes be placed on the bottom of all ground pins for better RF and thermal performance, as shown in the drawing at the left side.

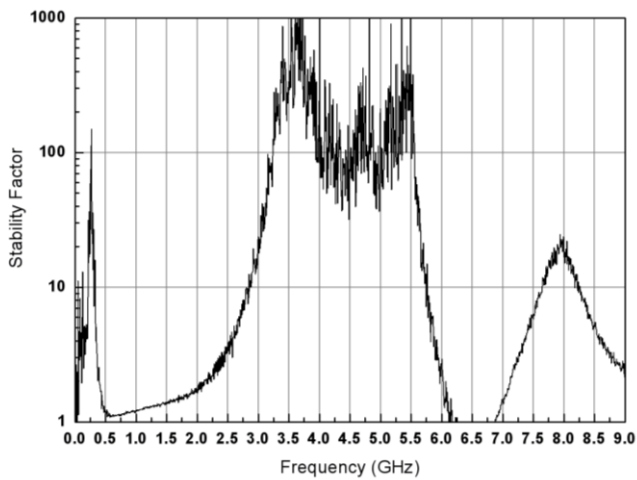
**Typical Performance
(Measured)**

890~960 MHz
+5 V

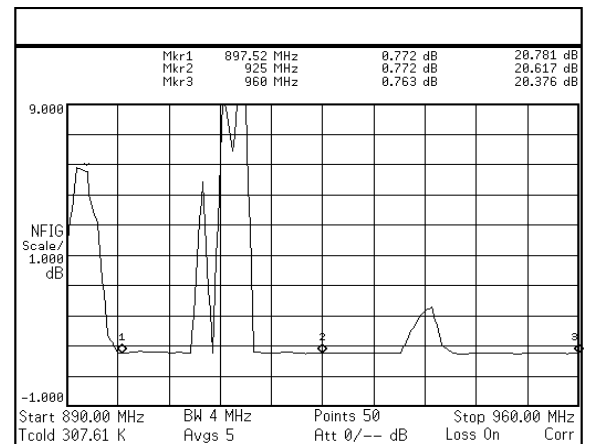
S-parameters



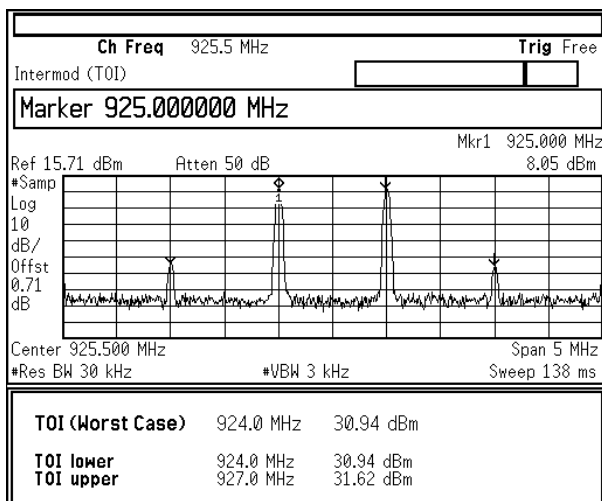
Stability Factor (K)



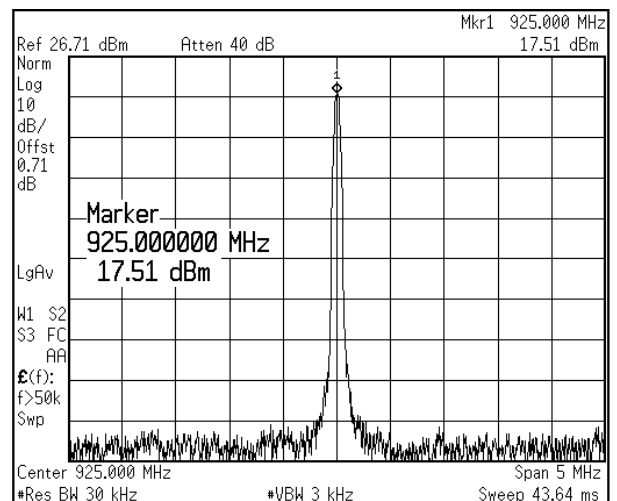
Noise Figure



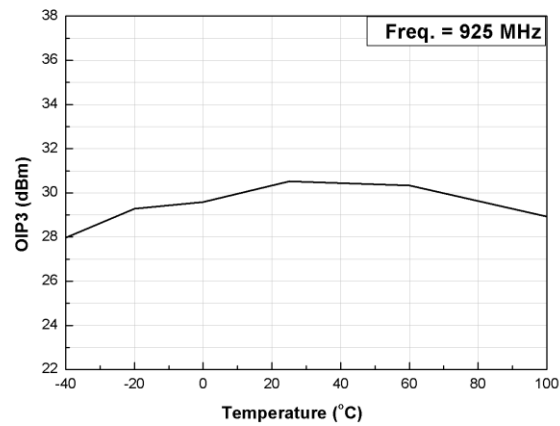
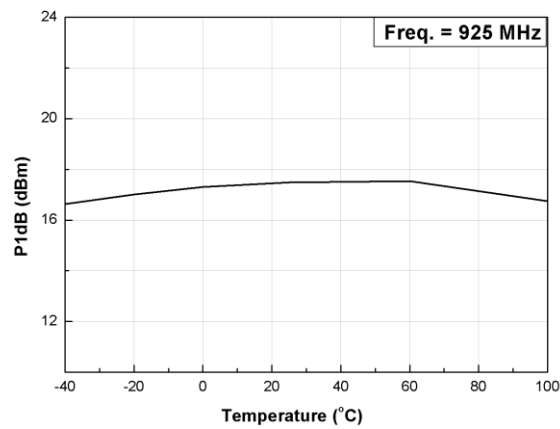
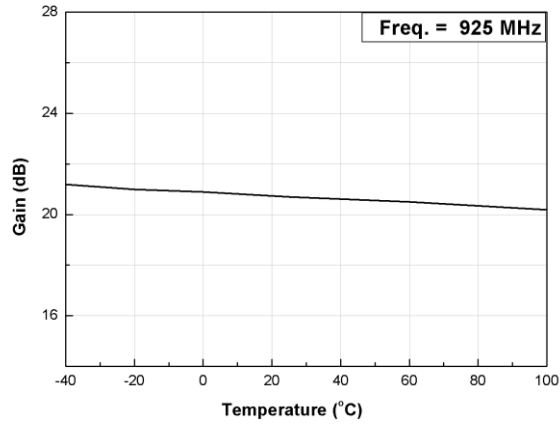
OIP3



P1dB

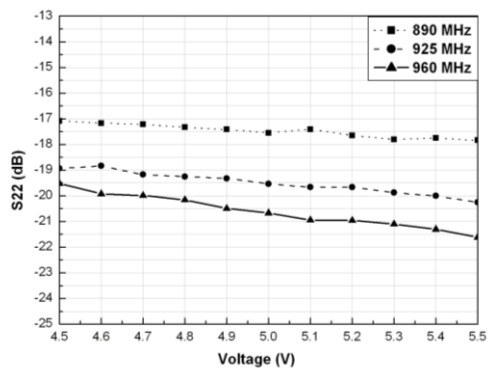
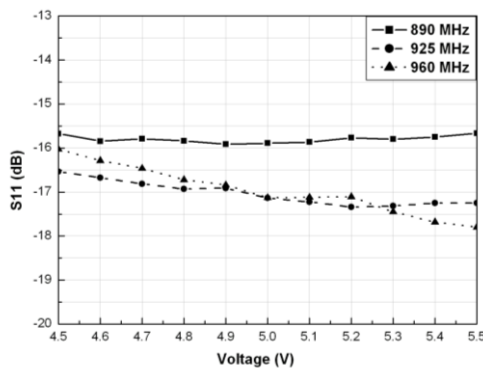
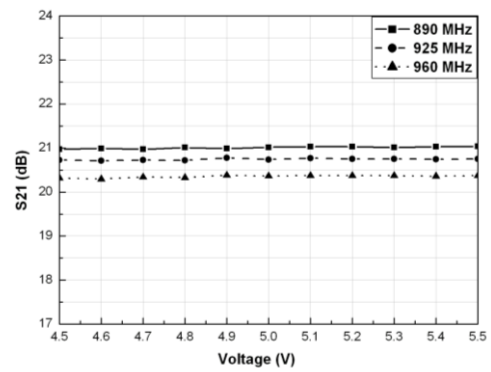
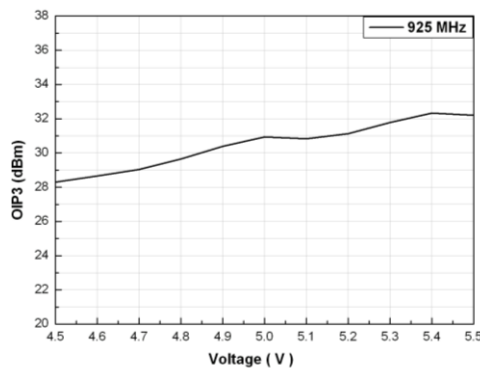
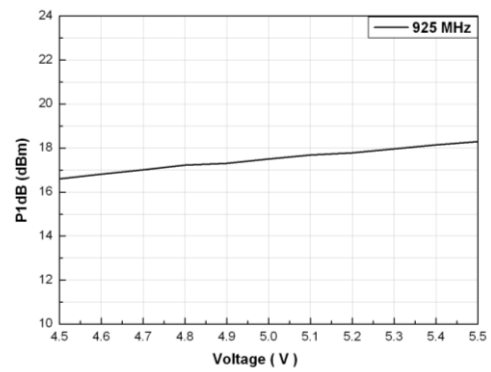
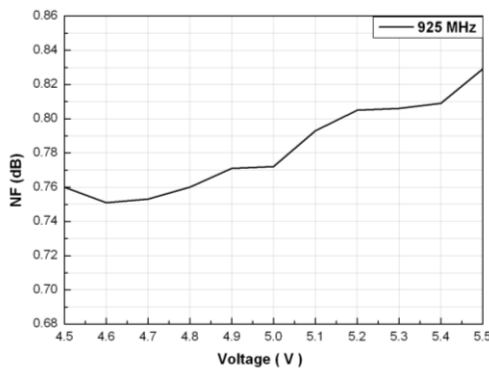


Gain, P1dB, and OIP3 with Temperature (-40°C ~ 100°C)

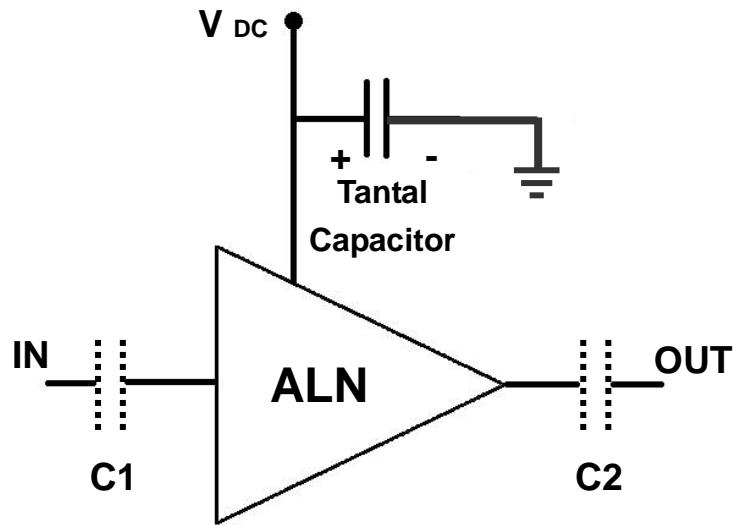


NF, P1dB, OIP3, and S-parameters with Voltage Change (4.5 V ~ 5.5 V)

Voltage (V)	Current (mA)	S21 (dB)			S11 (dB)			S22 (dB)			P1dB (dBm)	OIP3 (dBm)	NF (dB)	
		890 MHz	925 MHz	960 MHz	890 MHz	925 MHz	960 MHz	890 MHz	925 MHz	960 MHz				
4.5	62	20.975	20.731	20.319	-15.672	-16.532	-16.026	-17.083	-18.931	-19.519	16.6	28.29	0.76	
4.6	64	20.992	20.711	20.296	-15.841	-16.67	-16.285	-17.167	-18.838	-19.927	16.81	28.65	0.751	
4.7	65	20.971	20.727	20.343	-15.791	-16.811	-16.46	-17.218	-19.175	-19.989	17.02	29.03	0.753	
4.8	67	21.013	20.719	20.331	-15.833	-16.931	-16.719	-17.333	-19.252	-20.16	17.23	29.64	0.76	
4.9	68	20.988	20.779	20.381	-15.909	-16.91	-16.837	-17.419	-19.321	-20.493	17.31	30.39	0.771	
5	70	21.018	20.738	20.366	-15.89	-17.135	-17.127	-17.547	-19.536	-20.676	17.51	30.94	0.772	
5.1	71	21.031	20.77	20.376	-15.863	-17.222	-17.119	-17.406	-19.663	-20.947	17.69	30.83	0.793	
5.2	73	21.029	20.753	20.373	-15.764	-17.34	-17.104	-17.649	-19.659	-20.965	17.79	31.12	0.805	
5.3	74	21.017	20.754	20.374	-15.799	-17.317	-17.448	-17.807	-19.88	-21.1	17.97	31.78	0.806	
5.4	75	21.031	20.746	20.361	-15.75	-17.246	-17.683	-17.75	-20.005	-21.305	18.14	32.33	0.809	
5.5	76	21.04	20.75	20.374	-15.661	-17.25	-17.797	-17.842	-20.254	-21.616	18.3	32.2	0.829	
Variation	1	14	0.065	0.019	0.055	0.011	0.718	1.771	0.759	1.323	2.097	1.7	3.91	0.069

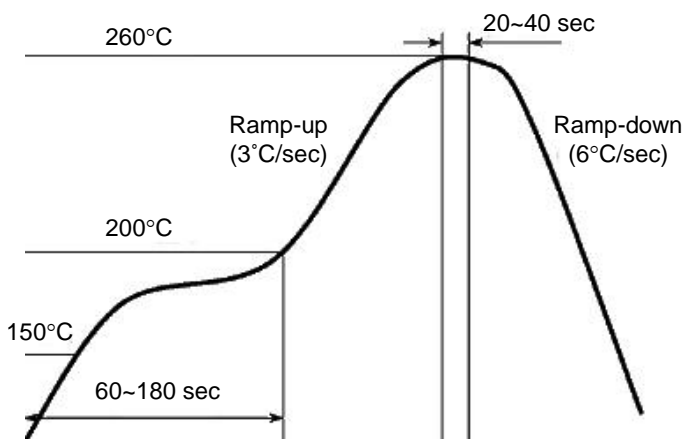


Application Circuit

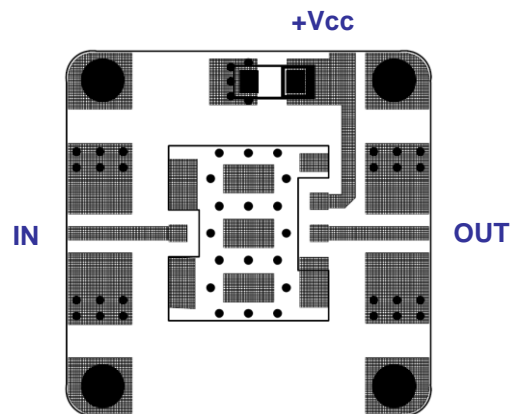


- 1) The tantalum capacitor is optional and for bypassing the AC noise introduced from the DC supply. The capacitance value may be determined by customer's DC supply status.
- 2) So-called DC blocking capacitors are always necessarily placed at the input and output port for allowing only the RF signal to pass and blocking the DC component in the signal. The DC blocking capacitors are included inside the LNA module. Therefore, C1 & C2 capacitors may not be necessary, but can be added just in case that the customer wants. The value of C1 & C2 is determined by considering the application frequency.

Recommended Soldering Reflow Process



Evaluation Board Layout



Size 25 x 25mm
(for ALN-AT, BT, T Series – 10x10mm)